

10A, 200V Trench Schottky Surface Mount Rectifier

FEATURES

- Patented Trench Schottky technology
- Excellent high temperature stability
- Low forward voltage
- Low power loss/ high efficiency
- High forward surge capability
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- DC to DC converters

MECHANICAL DATA

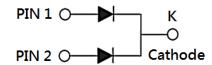
- Case: TO-263AB (D²PAK)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1A whisker test
- Polarity: As marked
- Weight: 1.60g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I _F	10	Α	
V_{RRM}	200	V	
I _{FSM}	100	Α	
T _{J MAX}	150	°C	
Package	TO-263AB (D ² PAK)		
Configuration	Dual dies		





TO-263AB (D²PAK)



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)			
PARAMETER	SYMBOL	TSD10L200CW	UNIT
Marking code on the device		TSD10L200CW	
Repetitive peak reverse voltage	V_{RRM}	200	V
Reverse voltage, total rms value	V _{R(RMS)}	140	V
Forward current	I _F	10	Α
Surge peak forward current, 8.3ms single half sine wave superimposed on rated load	I _{FSM}	100	А
Critical rate of rise of off-state voltage	dv/dt	10,000	V/µs
Junction temperature	T _J	- 55 to +150	°C
Storage temperature	T _{STG}	- 55 to +150	°C

1 Version: B2103



TSD10L200CW Taiwan Semiconductor

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	TINU
Junction-to-case thermal resistance	R _{eJC}	5	°C/W

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage per diode ⁽¹⁾	I _F = 5A, T _J = 25°C	V _F	0.84	0.90	V
	I _F = 10A, T _J = 25°C		0.92	0.98	V
	I _F = 5A, T _J = 125°C		0.72	0.78	V
	I _F = 10A, T _J = 125°C		0.80	0.86	V
Reverse current @ rated V _R per diode ⁽²⁾	T _J = 25°C	l _R	-	50	μA
	T _J = 125°C		-	5	mA

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE	PACKAGE	PACKING	
TSD10L200CW	TO-263AB (D ² PAK)	800 / Tape & Reel	



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

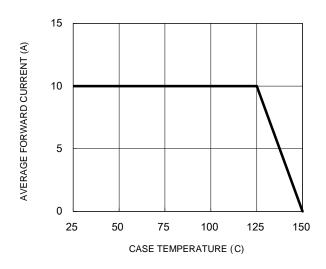


Fig.3 Typical Reverse Characteristics

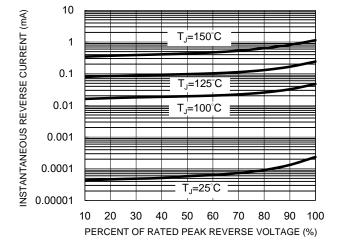


Fig.2 Typical Junction Capacitance

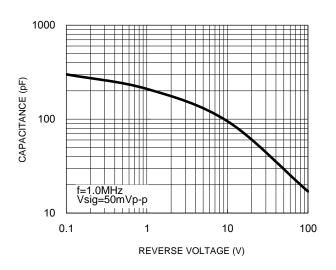
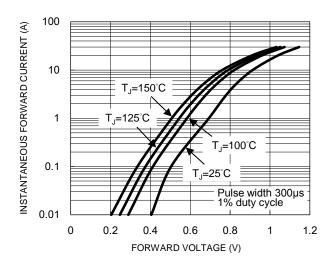


Fig.4 Typical Forward Characteristics

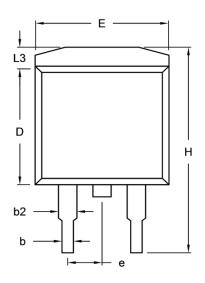


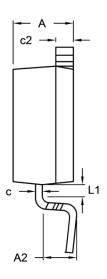
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PACKAGE OUTLINE DIMENSIONS

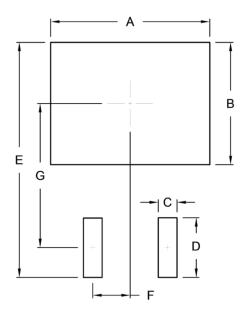
TO-263AB (D²PAK)





DIM Unit (mm)		Unit ((inch)	
Dilvi	Min	Max	Min	Max
Α	4.390	4.790	0.173	0.189
A2	2.540 (TYP)		0.100	(TYP)
b	0.675	0.975	0.027	0.038
b2	1.150	1.550	0.045	0.061
С	0.400	0.600	0.016	0.024
c2	1.150	1.450	0.045	0.057
D	8.250	9.250	0.325	0.364
E	9.600	10.050	0.378	0.396
е	2.540 (TYP)		0.100	(TYP)
Н	14.920	15.520	0.587	0.611
L1	0.900 (TYP)		0.035	(TYP)
L3	1.400 (TYP)		0.055	(TYP)

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
Α	10.80	0.425
В	8.30	0.327
С	1.27	0.050
D	4.05	0.159
E	15.95	0.628
F	2.54	0.100
G	9.775	0.385

MARKING DIAGRAM



= Marking Code P/N G = Green Compound

YWW = Date Code = Factory Code

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